**Product data sheet** 

## 1. General description

Planar passivated high commutation three quadrant triac in a TO92 plastic package intended for use in circuits where high static and dynamic dV/dt and high dl/dt can occur. This series triac will commutate the full rated RMS current at the maximum rated junction temperature without the aid of a snubber.

### 2. Features and benefits

- 3Q technology for improved noise immunity
- High blocking voltage capability
- · High commutation capability with maximum false trigger immunity
- High immunity to false turn-on by dV/dt
- · Less sensitive gate for high noise immunity
- Planar passivated for voltage ruggedness and reliability
- Triggering in three quadrants only

## 3. Applications

- · General purpose motor control circuits
- Home appliances
- Solenoid drivers

### 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Absolute	maximum rating					
$V_{DRM}$	repetitive peak off-state voltage		-	-	800	V
I <sub>T(RMS)</sub>	RMS on-state current	full sine wave; Fig. 1; Fig. 2; Fig. 3	-	-	3	А
I <sub>TSM</sub> non-repetitive peak on- state current		full sine wave; $t_p$ = 20 ms; $T_{j(init)}$ = 25 °C Fig. 4; Fig. 5	-	-	27	А
		full sine wave; $t_p$ = 16.7 ms; $T_{j(init)}$ = 25 °C	-	-	30	Α
T <sub>j</sub>	junction temperature		-	-	150	°C
Static cha	aracteristics					
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; } T2 + G + T_j = 25 \text{ °C; } Fig. 7$	-	-	10	mA
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T2 + G T_j = 25 \text{ °C}; Fig. 7$	-	-	10	mA
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T2- \text{G} T_j = 25 \text{ °C}; Fig. 7$	-	-	10	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 3 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	1.2	1.4	V

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Dynamic characteristics							
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 536 V; $T_{j}$ = 125 °C; ( $V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform; gate open circuit		500	-	-	V/µs
dl <sub>com</sub> /dt	rate of change of commutating current	$V_D$ = 400 V; $T_j$ = 150 °C; $I_{T(RMS)}$ = 3 A; $dV_{com}/dt$ = 20 V/ $\mu$ s; (snubberless condition); gate open circuit		2	-	-	A/ms

# 5. Pinning information

### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	T2	main terminal 2		NI
2	G	gate		T2—T1
3	T1	main terminal 1	(	sym051

# 6. Ordering information

#### Table 3. Ordering information

Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
BTA203-800ET	TO92	BTA203-800ETEP	Bulk	1000	SOT54	14-Nov-2013		
BTA203-800ET	TO92	BTA203-800ETQP	Reel	2000	SOT54 wide pitch	14-Nov-2013		
BTA203-800ET/L01	TO92	BTA203-800ET/L01EP	Bulk	500	SOT54/L01	14-Nov-2013		

# 7. Marking

### Table 4. Marking codes

Type number	Marking codes
BTA203-800ET	203-8E

# 8. Limiting values

### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{DRM}$	repetitive peak off-state voltage		-	-	800	V
I <sub>T(RMS)</sub>	RMS on-state current	full sine wave; Fig. 1; Fig. 2; Fig. 3	-	-	3	Α
I <sub>TSM</sub>	non-repetitive peak on- state current	full sine wave; $t_p$ = 20 ms; $T_{j(init)}$ = 25 °C; Fig. 4; Fig. 5	-	-	27	А
		full sine wave; $t_p = 16.7 \text{ ms}$ ; $T_{j(init)} = 25 ^{\circ}\text{C}$	-	-	30	А
l <sup>2</sup> t	l <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms; sine wave	-	-	3.7	A <sup>2</sup> s
dl <sub>⊤</sub> /dt	rate of rise of on-state current	I <sub>G</sub> = 20 mA	-	-	100	A/µs
I <sub>GM</sub>	peak gate current		-	-	2	А
P <sub>GM</sub>	peak gate power		-	-	5	W
$P_{G(AV)}$	average gate power	over any 20 ms period	-	-	0.5	W
T <sub>stg</sub>	storage temperature		-40	-	150	°C
T <sub>j</sub>	junction temperature		-40	-	150	°C

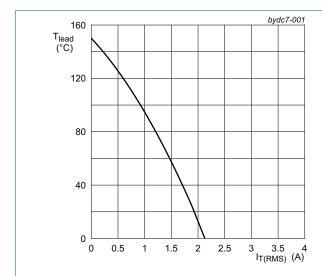
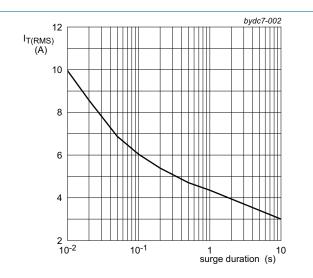


Fig. 1. RMS on-state current as a function of lead temperature; maximum values

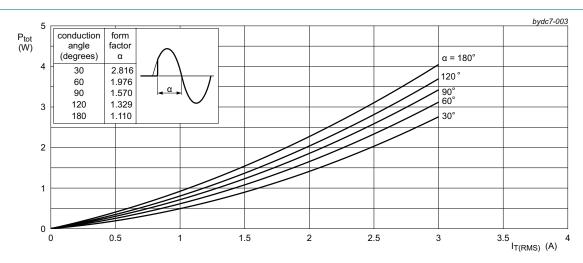


f = 50 Hz

Fig. 2. RMS on-state current as a function of surge duration; maximum values

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**3Q Hi-Com Triac** 



 $\alpha$  = conduction angle

a = form factor =  $I_{T(RMS)}$  /  $I_{T(AV)}$ 

Fig. 3. Total power dissipation as a function of RMS on-state current; maximum values

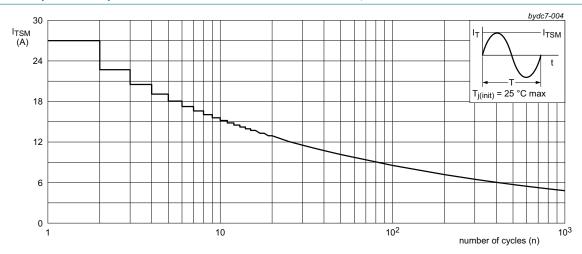
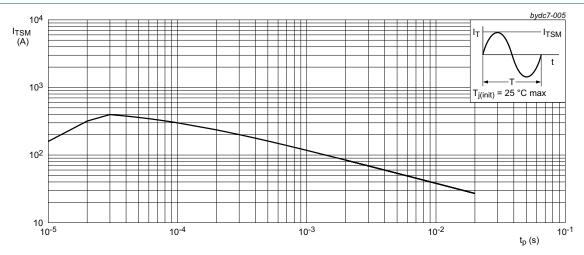


Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values



 $t_{D} \le 20 \text{ ms}$ ;  $(1) dI_{\tau}/dt limit$ 

BTA203-800ET

Total power dissipation as a function of RMS on-state current; maximum values

### 9. Thermal characteristics

**Table 5. Thermal characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-lead)}}$	thermal resistance from junction to lead	<u>Fig. 6</u>	-	-	60	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	150	-	K/W

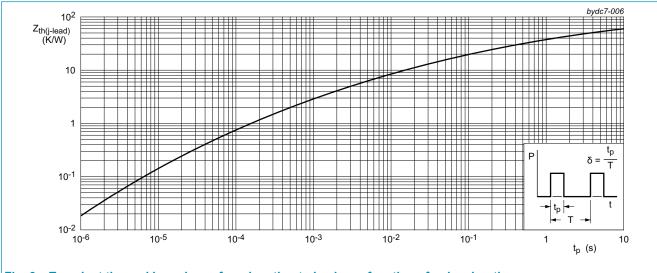
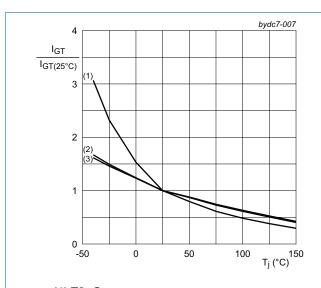


Fig. 6. Transient thermal impedance from junction to lead as a function of pulse duration

## 10. Characteristics

#### **Table 7. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					'
l <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; } T2 + G+;$ $T_j = 25 \text{ °C; } Fig. 7$	-	-	10	mA
		$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; } T2 + G-;$ $T_j = 25 \text{ °C; } Fig. 7$	-	-	10	mA
		$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; } T2- \text{ G-;}$ $T_j = 25 \text{ °C; } \underline{\text{Fig. } 7}$	-	-	10	mA
I <sub>L</sub>	latching current	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; } T2+ \text{ G+;} $ $T_j = 25 \text{ °C; } \underline{\text{Fig. 8}}$	-	-	30	mA
		$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; } T2 + G-;$ $T_j = 25 \text{ °C; } \underline{Fig. 8}$	-	-	40	mA
		$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; T2- G-;}$ $T_j = 25 \text{ °C; } Fig. 8$	-	-	30	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>	-	-	20	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 3 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	1.2	1.4	V
$V_{GT}$	gate trigger voltage	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; } T_j = 25 \text{ °C;}$ Fig. 11	-	0.7	1	V
		V <sub>D</sub> = 400 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 150 °C	0.25	0.45	-	V
I <sub>D</sub>	off-state current	V <sub>D</sub> = 800 V; T <sub>j</sub> = 25 °C	-	-	5	μA
		V <sub>D</sub> = 800 V; T <sub>j</sub> = 150 °C	-	-	0.5	mA
Dynamic o	characteristics		'	'	'	
dV <sub>D</sub> /dt	rate of rise of off-state voltage	ve of off-state $V_{DM}$ = 536 V; $T_j$ = 125 °C; $(V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform; gate open circuit		-	-	V/µs
dl <sub>com</sub> /dt	rate of change of commutating current	$V_D = 400 \text{ V}; T_j = 150 \text{ °C}; I_{T(RMS)} = 3 \text{ A};$ $dV_{com}/dt = 20 \text{ V/}\mu\text{s}; \text{ (snubberless)}$ condition); gate open circuit	2	-	-	A/ms



(1) T2- G-

0 <del>-</del>50

Fig. 7. Normalized gate trigger current as a function of

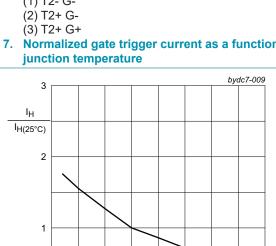


Fig. 9. Normalized holding current as a function of junction temperature

50

0

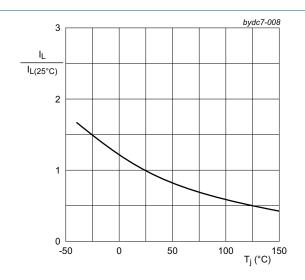
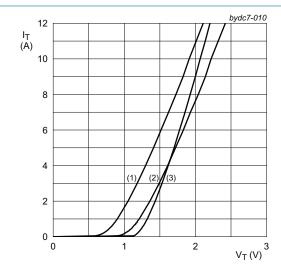


Fig. 8. Normalized latching current as a function of junction temperature



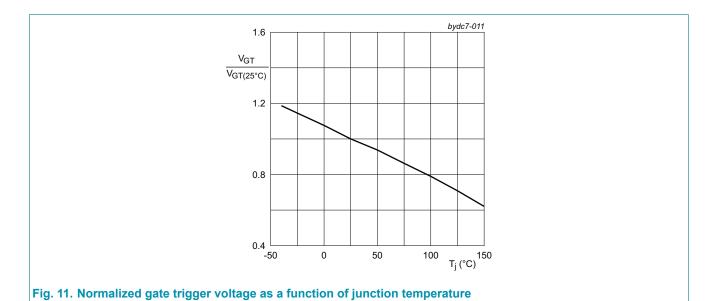
 $V_o$  = 0.787 V;  $R_s$  = 0.2133  $\Omega$ 

(1) T<sub>j</sub> = 150 °C; typical values (2) T<sub>j</sub> = 150 °C; maximum values

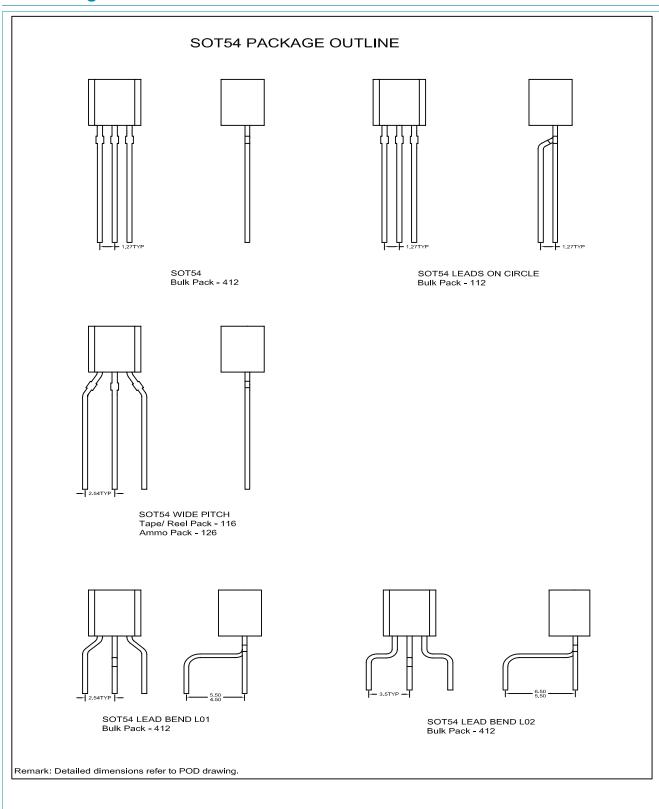
(3) T<sub>i</sub> = 25 °C; maximum values

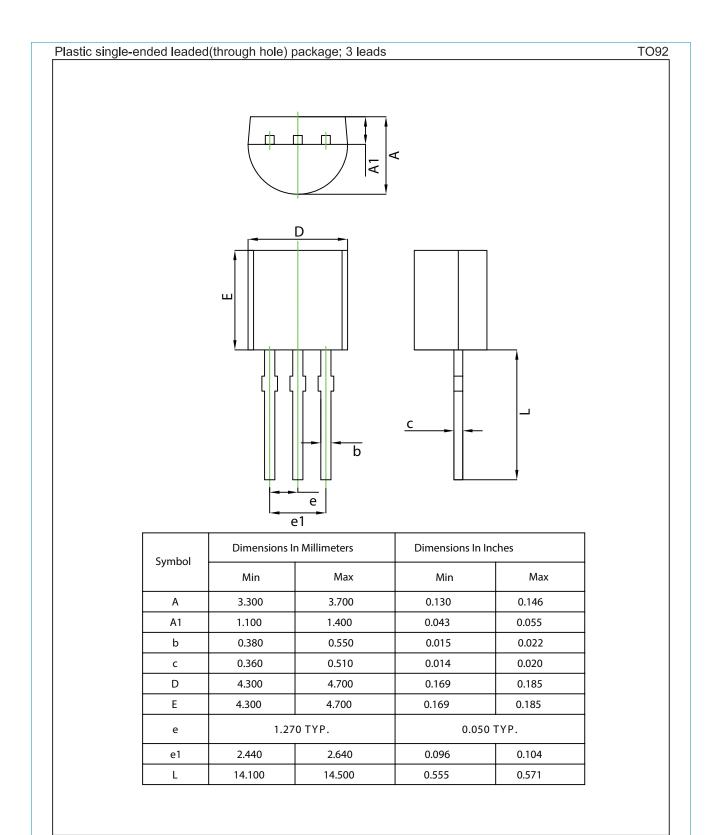
Fig. 10. On-state current as a function of on-state voltage

T<sub>j</sub> (°C) 150



# 11. Package outline





## 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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